

Common-mode chokes, ring core 4.7 ... 68 mH, 200 ... 700 mA, 60 °C

Series/Type: B82794C0

Date: January 2010

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B82794C0

Common-mode chokes, ring core

SMD

Rated voltage 42 V AC/80 V DC Rated inductance 4.7 mH to 68 mH Rated current 200 mA to 700 mA

Construction

- Current-compensated ring core double choke
- Ferrite core
- LCP case (UL 94 V-0)
- Silicone potting
- Bifilar winding

Features

- Suitable for reflow soldering
- RoHS-compatible

Function

Suppression of asymmetrical interference coupled in on lines, whereas data signals up to some MHz can pass unaffectedly.

Applications

- Telecom applications
- RF equipment

Terminals

- Base material CuSn6
- Layer composition Ni, Sn
- Hot-dipped

Marking

- Marking on component:
 Manufacturer, ordering code, inductance, graphic symbol, date of manufacture (YYWWD)
- Minimum data on reel:
 Manufacturer, ordering code,
 L value, current, quantity, date of packing

Delivery mode and packing unit

- 24-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 250 pcs./reel



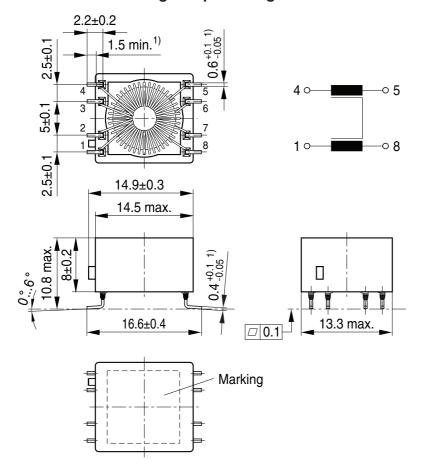


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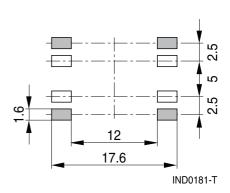
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Dimensional drawing and pin configuration



Layout recommendation



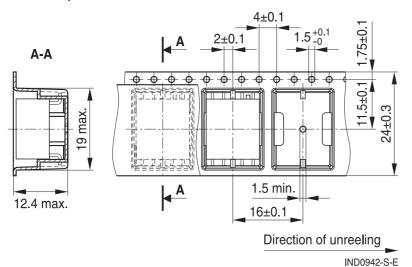
1) Soldering area

IND0180-P-E

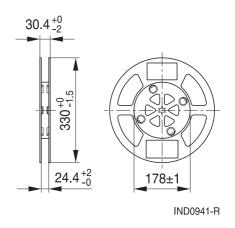
Dimensions in mm

Taping and packing

Blister tape



Reel



Dimensions in mm



	Data:	and	signal	line o	chokes
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Technical data and measuring conditions

Rated voltage V _R	42 V AC (50/60 Hz) / 80 V DC		
Rated temperature T _R	60 °C		
Rated current I _R	Referred to 50 Hz and rated temperature		
Rated inductance L _R	Measured with Agilent 4284A at 10 kHz, 50 mV, 20 °C Inductance is specified per winding.		
Inductance tolerance	−30%/+50% at 20 °C		
Inductance decrease ΔL/L ₀	< 10% at DC magnetic bias with I _R , 20 °C		
Stray inductance L _{stray,typ}	Measured with Agilent 4284A at 10 kHz, 50 mV, 20 °C, typical values		
DC resistance R _{typ}	Measured at 20 °C, typical values, specified per winding		
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: (245 \pm 5) °C, (3 \pm 0.3) s Wetting of soldering area \geq 95% (to IEC 60068-2-58)		
Resistance to soldering heat	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-58)		
Climatic category	40/125/56 (to IEC 60068-1)		
Storage conditions (packaged)	–25 °C +40 °C, ≤75% RH		
Weight	Approx. 2.7 g		

Characteristics and ordering codes

L_{R}	L _{stray,typ}	I _R	R _{typ}	V _{test}	Ordering code
mH	nH	mA	mΩ	V DC, 2 s	
4.7	350	700	500	750	B82794C0475N465
10	450	600	700	750	B82794C0106N465
28	800	400	1200	750	B82794C0286N465
47	1200	300	2800	750	B82794C0476N465
68	1300	200	3400	750	B82794C0686N465

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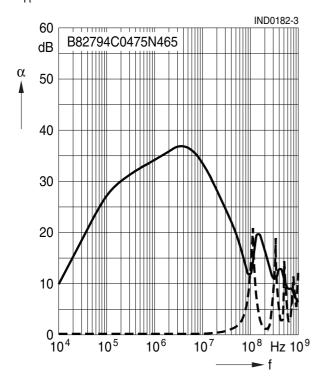
SMD

Insertion loss α (typical values at $|Z| = 50 \Omega$, 20 °C)

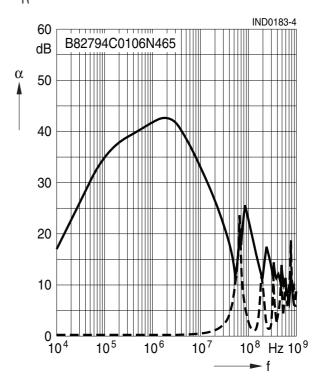
asymmetrical, all branches in parallel (common mode)

- - - - - - symmetrical (differential mode)

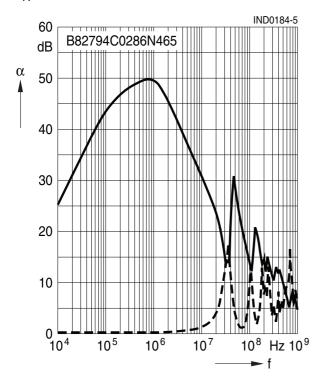
$$L_{R} = 4.7 \text{ mH}$$



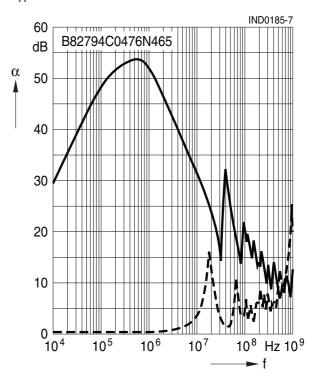
$$L_R = 10 \text{ mH}$$



$$L_{R} = 28 \text{ mH}$$



 $L_B = 47 \text{ mH}$



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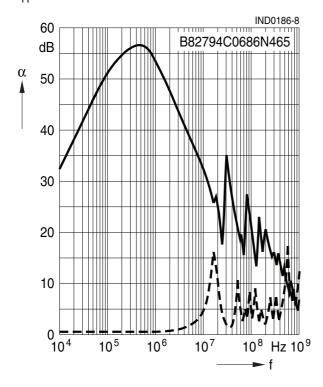
SMD

Insertion loss α (typical values at $|Z| = 50 \Omega$, 20 °C)

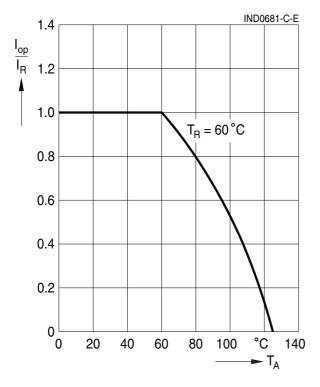
asymmetrical, all branches in parallel (common mode)

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 $L_R = 68 \text{ mH}$



Current derating I_{op}/I_R versus ambient temperature





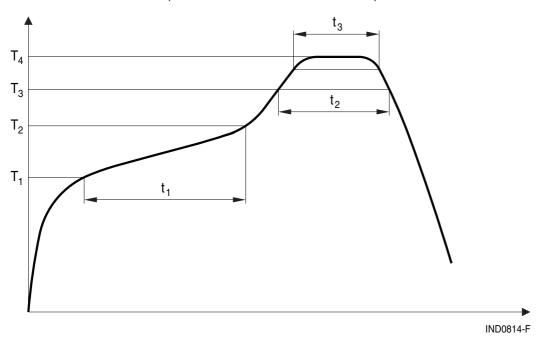
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Recommended reflow soldering curve

Pb-free solder material (based on JEDEC J-STD 020C)



T ₁	T ₂	T ₃	T ₄	t ₁	t ₂	t ₃
°C	°C	°C	°C	s	s	S
150	200	217	245	< 110	< 90	< 30 @ T ₄ –5 °C

Time from 25 °C to T_4 : max 300 s Maximal numbers of reflow cycles: 3



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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